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RECC



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To the Director of the U.S. Patent and Trade
or the new address(es) below.

1. Name of conveying party(ies)
1) Gee Sung CHAE (05/16/2007)
2) Seung Hwan CHA (05/16/2007)

Additional name(s) of conveying party(ies) attached? Yes No

Name of receiving party(ies)
Name: LG.Phillips LCD CO., LTD.
Internal Address: _____

3. Nature of conveyance/Execution Date(s):
Execution Date(s) May 16, 2007
 Assignment Merger
 Security Agreement Change of Name
 Joint Research Agreement
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other

Street Address: 20 Yoido-dong
Youngdungpo-ku
City: Seoul
State: _____
Country: Republic of Korea Zip: _____
Additional name(s) & address(es) attached? Yes No

4. Application or patent number(s): This document is being filed together with a new application.
A. Patent Application No.(s)
11/802541

B. Patent No.(s)
Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:
Name: Sunwoo Lee
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6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
 Authorized to be charged by credit card
 Authorized to be charged to deposit account
 Enclosed
 None required (government interest not affecting title)

8. Payment Information
a. Credit Card Last 4 Numbers _____
Expiration Date _____
b. Deposit Account Number _____
Authorized User Name _____

9. Signature: _____ May 23, 2007
Signature Date
Sunwoo Lee, Registration No. 43,337
Name of Person Signing
Total number of pages including cover sheet, attachments, and document: 3

ASSIGNMENT

WHEREAS we, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

THIN FILM TRANSISTOR, METHOD OF FABRICATING THE SAME, AND METHOD OF FABRICATING LIQUID CRYSTAL DISPLAY DEVICE HAVING THE SAME

for which we executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Application No. _____); and

WHEREAS, **LG.Philips LCD Co., Ltd.**, a corporation of **Republic of Korea**, whose post office address is **20, Yoido-dong, Youngdungpo-gu, Seoul, Republic of Korea**, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, we, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and we hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY further covenant and agree that we will, without further consideration, communicate with assignee, its successors and assigns, any facts known to us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, WE HEREBY authorize and request the attorneys we have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, we have hereunto set our hands.

Full Name of First Assignor Gee Sung CHAE	Assignor's Signature <i>Gee Sung Chae</i>	Date May 16, 2007
Address: 111-607 Hanyang 1 Cha Apt., Dongchun-dong, Yeonsu-gu Incheon, Republic of Korea		Citizenship Republic of Korea

Names of additional inventors attached Yes No

Full Name of Second Assignor Seung Hwan CHA	Second Assignor's Signature <i>Seung Hwan CHA</i>	Date May. 16. 2007
Address: 112 ho, Bockum Apt., 384-3(9/5) Ganseok 4-dong, Namdong-gu Incheon, Republic of Korea		Citizenship Republic of Korea

Names of additional inventors attached Yes No